

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>KIICHI KAWABATA</td> <td>12/10/2013</td> </tr> <tr> <td>AKIO TAJIMA</td> <td>12/10/2013</td> </tr> <tr> <td>TAKASHI MATSUO</td> <td>12/12/2013</td> </tr> <tr> <td>YOSHIKO WATANABE</td> <td>12/18/2013</td> </tr> <tr> <td>KOICHI AYAMA</td> <td>12/27/2013</td> </tr> </tbody> </table>		Name	Execution Date	KIICHI KAWABATA	12/10/2013	AKIO TAJIMA	12/10/2013	TAKASHI MATSUO	12/12/2013	YOSHIKO WATANABE	12/18/2013	KOICHI AYAMA	12/27/2013
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<table border="1"> <tr> <td>Name:</td> <td>JNC CORPORATION</td> </tr> <tr> <td>Street Address:</td> <td>2-1, OTEMACHI 2-CHOME, CHIYODA-KU,</td> </tr> <tr> <td>City:</td> <td>TOKYO</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>100-8105</td> </tr> </table>		Name:	JNC CORPORATION	Street Address:	2-1, OTEMACHI 2-CHOME, CHIYODA-KU,	City:	TOKYO	State/Country:	JAPAN	Postal Code:	100-8105		
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Application Number:	14130499												
CORRESPONDENCE DATA													
Fax Number:	(510)580-7280												
Email:	usa@jccipgroup.com.tw												
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>													
Correspondent Name:	JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE												
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Address Line 4:	TAIPEI, TAIWAN 100												
ATTORNEY DOCKET NUMBER:	43375-US-033-PCT												
NAME OF SUBMITTER:	BELINDA LEE												
Signature:	/Belinda Lee/												

Date:

02/06/2014

Total Attachments: 2

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ASSIGNMENT

WHEREAS,

1. Kiichi KAWABATA
2. Akio TAJIMA
3. Takashi MATSUO
4. Yoshiko WATANABE
5. Koichi AYAMA

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **COMPOUND INCLUDING ORGANOPOLYSILOXANE OR SILSESQUIOXANE SKELETON HAVING ISOCYANURIC SKELETON, EPOXY GROUP AND SIH GROUP, THERMOSETTING RESIN COMPOSITION CONTAINING THE COMPOUND AS ADHESION-IMPARTING AGENT, HARDENED MATERIAL AND SEALING AGENT FOR OPTICAL SEMICONDUCTOR**

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, **JNC CORPORATION**
of 2-1, OTEMACHI 2-CHOME, CHIYODA-KU, TOKYO 100-8105 JAPAN

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Kiichi KAWABATA
Sole or First Joint Inventor: Kiichi KAWABATA

Date: December 10, 2013

Signature: Akio TAJIMA
Second Joint Inventor: Akio TAJIMA

Date: December 10, 2013

Signature: Takashi MATSUO
Third Joint Inventor: Takashi MATSUO

Date: December 12, 2013

Signature: Yoshiko WATANABE
Fourth Joint Inventor: Yoshiko WATANABE

Date: December 18, 2013

Signature: Koichi Ayama
Fifth Joint Inventor: Koichi AYAMA

Date: December 27, 2013